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FDMC86259P P-Channel PowerTrench[®] MOSFET -150 V, -13 A, 107 m Ω

Features

- Max $r_{DS(on)}$ = 107 m Ω at V_{GS} = -10 V, I_D = -3 A
- Max r_{DS(on)} = 137 mΩ at V_{GS} = -6 V, I_D = -2.7 A
- Very low RDS-on mid voltage P channel silicon technology optimised for low Qg
- This product is optimised for fast switching applications as well as load switch applications
- 100% UIL Tested
- RoHS Compliant

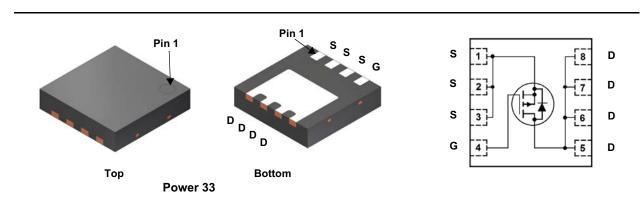


General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Applications

- Active Clamp Switch
- Load Switch



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			-150	V	
V _{GS}	Gate to Source Voltage			±25	V	
Ι _D	Drain Current -Continuous	T _C = 25 °C		-13		
	-Continuous	T _A = 25 °C	(Note 1a)	-3.2	Α	
	-Pulsed			-20		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	181	mJ	
P _D	Power Dissipation	T _C = 25 °C		62		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to + 150	°C	

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction to Case		2.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	C/vv

Package Marking and Ordering Information

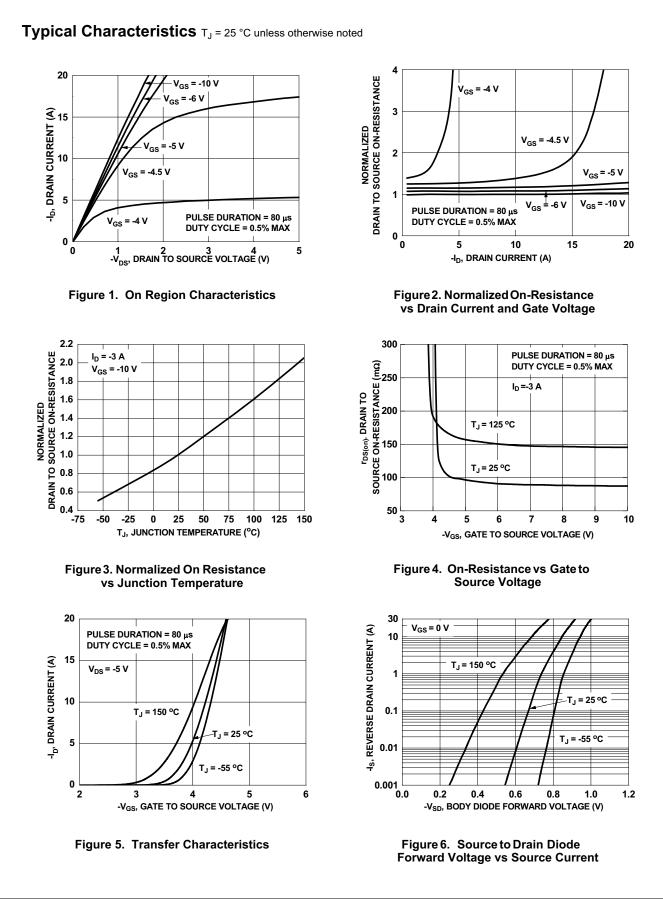
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86259P	FDMC86259P	Power 33	13"	12 mm	3000 units

February 2014

cteristics	Test Conditions	Min	Тур	Max	Units
Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-150			V
Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-88		mV/°C
Zero Gate Voltage Drain Current	V _{DS} = -120 V, V _{GS} = 0 V			-1	μA
Gate to Source Leakage Current	V _{GS} = ±25 V, V _{DS} = 0 V			±100	nA
teristics					
1	$V_{00} = V_{00}$ $l_{0} = -250 \mu A$	-2	-2.8	-4	V
			2.0	•	
Temperature Coefficient			6		mV/°C
	V _{GS} = -10 V, I _D = -3 A		87	107	
Static Drain to Source On Resistance	V _{GS} = -6 V, I _D = -2.7 A		99	137	mΩ
	V_{GS} = -10 V, I_{D} = -3 A, T_{J} = 125 °C		145	178	
Forward Transconductance	V _{DS} = -10 V, I _D = -3 A		12		S
Characteristics					
Input Capacitance			1535	2045	pF
Output Capacitance			125	170	pF
Reverse Transfer Capacitance			6	10	pF
Gate Resistance		0.1	1.4	3	Ω
Turn-On Delay Time Rise Time	Vpp = -75 V lp = -3 A		12 3.3	23 10	ns ns
Turn-Off Delay Time			22	36	ns
Fall Time			9.6	20	ns
Total Gate Charge	$V_{GS} = 0 V \text{ to } -10 V$		22	32	nC
Total Gate Charge	$V_{GS} = 0 V \text{ to } -6 V$ $V_{DD} = -75 V,$ $I_D = -3 A$		14	20	nC
Total Gate Charge			5.7		nC
Gate to Drain "Miller" Charge			4.3		nC
rce Diode Characteristics					
rce Diode Characteristics	V _{GS} = 0 V, I _S = -3 A (Note 2)		-0.80	-1.3	V
rce Diode Characteristics Source to Drain Diode Forward Voltage			-0.80 -0.78	-1.3 -1.2	V V
	Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge	Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}$, $I_D = -250 \ \mu A$ Gate to Source Threshold Voltage Temperature Coefficient $I_D = -250 \ \mu A$, referenced to 25 °CStatic Drain to Source On Resistance $V_{GS} = -10 \ V$, $I_D = -3 \ A$ VGS = -10 V, $I_D = -3 \ A$ $V_{GS} = -6 \ V$, $I_D = -2.7 \ A$ VGS = -10 V, $I_D = -3 \ A$, $T_J = 125 \ °C$ Forward Transconductance $V_{DS} = -10 \ V$, $I_D = -3 \ A$ CharacteristicsInput Capacitance Output Capacitance $V_{DS} = -75 \ V$, $V_{GS} = 0 \ V$, $f = 1 \ MHz$ Reverse Transfer Capacitance $V_{DS} = -75 \ V$, $V_{GS} = 0 \ V$, $f = 1 \ MHz$ CharacteristicsTurn-On Delay Time Rise Time Turn-Off Delay Time $V_{DD} = -75 \ V$, $I_D = -3 \ A$, $V_{GS} = -10 \ V$, $R_{GEN} = 6 \ \Omega$ Fall Time $V_{GS} = 0 \ V \ to -10 \ V$ $I_D = -3 \ A$ Total Gate Charge $V_{GS} = 0 \ V \ to -10 \ V$ $I_D = -3 \ A$	Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}$, $I_D = -250 \ \mu A$ -2 Gate to Source Threshold Voltage Temperature Coefficient $I_D = -250 \ \mu A$, referenced to $25 \ ^{\circ}C$ $V_{GS} = -10 \ V$, $I_D = -3 \ A$ $V_{GS} = -10 \ V$, $I_D = -3 \ A$ Static Drain to Source On Resistance $V_{GS} = -6 \ V$, $I_D = -2.7 \ A$ $V_{GS} = -10 \ V$, $I_D = -3 \ A$, $T_J = 125 \ ^{\circ}C$ Forward Transconductance $V_{DS} = -10 \ V$, $I_D = -3 \ A$ $V_{CS} = -10 \ V$, $I_D = -3 \ A$ SharacteristicsInput Capacitance Output Capacitance $V_{DS} = -75 \ V$, $V_{GS} = 0 \ V$, $f = 1 \ MHz$ I_{CO} Gate Resistance 0.1 CharacteristicsTurn-On Delay Time Rise Time $V_{DD} = -75 \ V$, $I_D = -3 \ A$, $V_{GS} = -10 \ V$, $R_{GEN} = 6 \ \Omega$ Turn-Off Delay Time $V_{GS} = 0 \ V \ to -10 \ V$ $I_D = -3 \ A$ Total Gate Charge $V_{GS} = 0 \ V \ to -6 \ V$ $I_D = -3 \ A$	Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}$, $I_D = -250 \ \mu A$, referenced to 25 °C-2-2.8Gate to Source Threshold Voltage Temperature Coefficient $I_D = -250 \ \mu A$, referenced to 25 °C6Static Drain to Source On Resistance $V_{GS} = -10 \ V$, $I_D = -3 \ A$ 87 $V_{GS} = -10 \ V$, $I_D = -3 \ A$ 99 $V_{GS} = -10 \ V$, $I_D = -3 \ A$ 99 $V_{GS} = -10 \ V$, $I_D = -3 \ A$ 12Forward Transconductance $V_{DS} = -75 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz1535Input Capacitance Gate Resistance $V_{DS} = -75 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz125Reverse Transfer Capacitance Gate Resistance0.1 1.4Characteristics $V_{DD} = -75 \ V$, $I_D = -3 \ A$, $V_{GS} = -10 \ V$, $R_{GEN} = 6 \ \Omega$ 22Turn-On Delay Time Fall Time $V_{GS} = 0 \ V$ to $-10 \ V$ $V_{GS} = 0 \ V$ to $-10 \ V$ $I_D = -3 \ A$ 22Fall Time Total Gate Charge $V_{GS} = 0 \ V$ to $-10 \ V$ $I_D = -3 \ A$ 22Total Gate Charge $V_{GS} = 0 \ V \ to -6 \ V$ $I_D = -3 \ A$ 22	Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = -250 \ \mu A$, referenced to 25 °C -2 -2.8 -4 Gate to Source Threshold Voltage Temperature Coefficient $I_D = -250 \ \mu A$, referenced to 25 °C 6 6 Static Drain to Source On Resistance $V_{GS} = -10 \ V, \ I_D = -3 \ A$ 87 107 V _{GS} = -6 \ V, \ I_D = -2.7 \ A 99 137 V _{GS} = -10 \ V, \ I_D = -3 \ A, \ T_J = 125 \ °C 145 178 Forward Transconductance $V_{DS} = -10 \ V, \ I_D = -3 \ A$ 12 12 Characteristics Input Capacitance $V_{DS} = -75 \ V, \ V_{GS} = 0 \ V, f = 1 \ MHz$ 1535 2045 Output Capacitance $V_{DS} = -75 \ V, \ V_{GS} = 0 \ V, f = 1 \ MHz$ 125 170 Reverse Transfer Capacitance $V_{DS} = -75 \ V, \ V_{GS} = 0 \ V, f = 1 \ MHz$ 12 23 Characteristics $V_{DD} = -75 \ V, \ I_D = -3 \ A, V_{DS} = -10 \ V, \ R_{GEN} = 6 \ \Omega$ 3.3 10 Turn-On Delay Time $V_{GS} = -10 \ V, \ R_{GEN} = 6 \ \Omega$ 22 36 Fall Time $9.6 \ 20$ 22 36 Fall Time $V_{GS} = 0 \ V \ to -6 \ V \ $

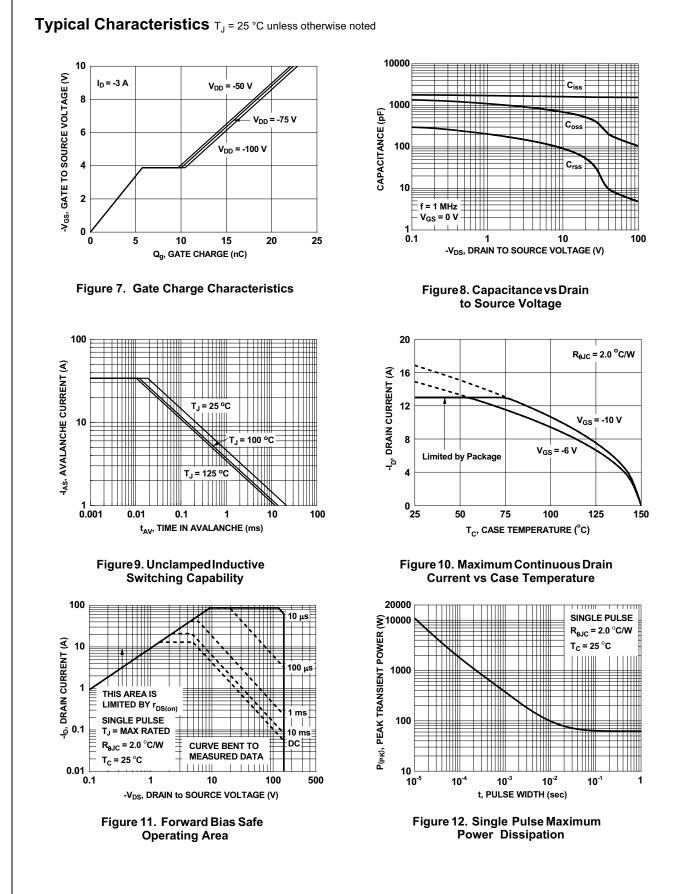
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25 °C; P-ch: L = 3 mH, I_{AS} = -11 A, V_{DD} = -150 V, V_{GS} = -10 V. 100% test at L = 0.1 mH, I_{AS} = -34 A.

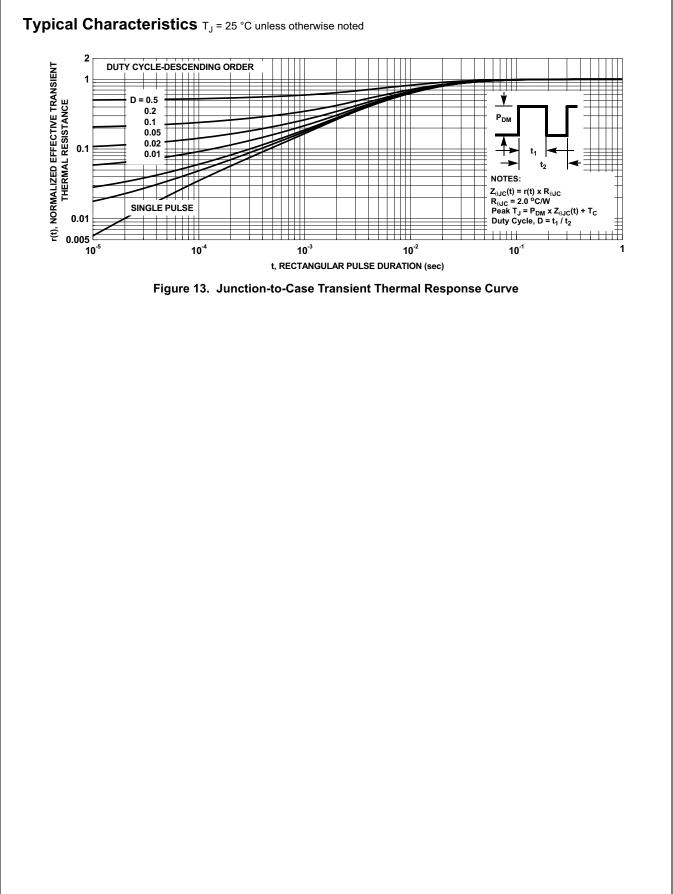


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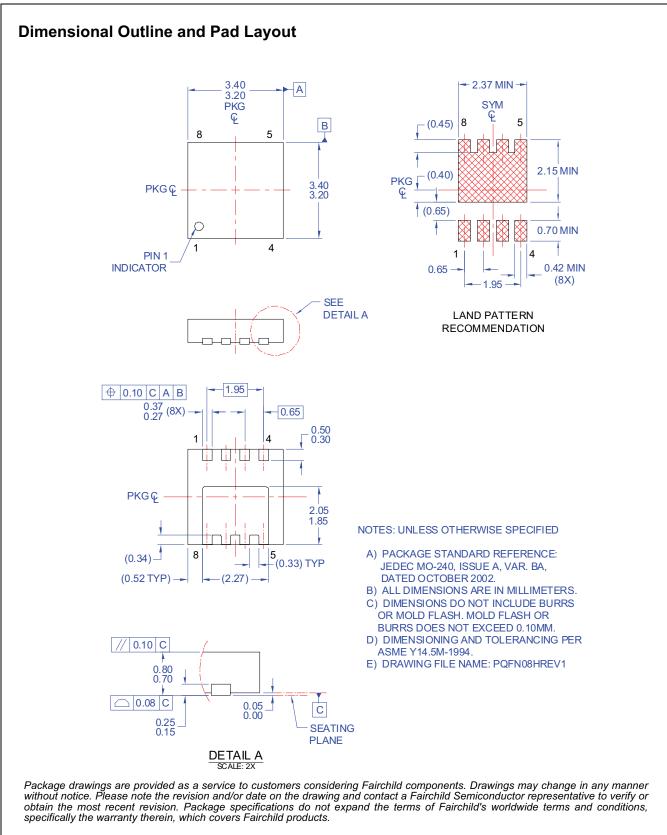




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FDMC86259P P-Channel PowerTrench[®] MOSFET



Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/PQ/PQFN08H.pdf. FDMC86259P P-Channel PowerTrench[®] MOSFET



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